**Product data sheet** 

# 1. General description

Ultrafast power diode (Bare die after sawn).

## 2. Features and benefits

- Fast reverse recovery
- Low leakage current
- · Low forward voltage drop
- Bare die

## 3. Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>RRM</sub> *	repetitive peak reverse voltage			-	-	600	V
I <sub>F(AV)</sub> **	average forward current	$\delta$ = 0.5; square-wave pulse		-	-	15	Α
Static ch	Static characteristics						
V <sub>F</sub> **	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C		-	1.4	1.8	V
Dynamic characteristics							
t <sub>rr</sub> **	reverse recovery time	$I_F = 1 \text{ A}$ ; $V_R = 30 \text{ V}$ ; $dI_F/dt = 100 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$		-	28	60	ns

## 4. Ordering information

## **Table 2. Ordering information**

Type number	Package			
	Name	Description	Version	
WNB111S5APTS	Wafer	Bare die on wafer	Die	

# 5. Limiting values

#### **Table 3. Limiting values**

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>RRM</sub> *	repetitive peak reverse voltage		-	600	V
V <sub>RWM</sub> *	crest working reverse voltage		-	600	V
V <sub>R</sub> *	reverse voltage	DC	-	600	V
I <sub>F(AV)</sub> **	average forward current	δ = 0.5; square-wave pulse	-	15	Α
I <sub>FRM</sub> **	repetitive peak forward current	$\delta$ = 0.5; $t_p$ = 25 µs; square-wave pulse	-	30	Α
I <sub>FSM</sub> **	non-repetitive peak forward current	$t_p$ = 10 ms; $T_{j(init)}$ = 25 °C; sine-wave pulse	-	180	А
		$t_p$ = 8.3 ms; $T_{j(init)}$ = 25 °C;sine-wave pulse	-	200	А
T <sub>stg</sub> **	storage temperature		-65	175	°C
T,**	junction temperature		-	175	°C

## 6. Characteristics

#### **Table 4. Characteristics**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					`
V <sub>F</sub> *	forward voltage	I <sub>F</sub> = 5 A; T <sub>j</sub> = 25 °C	-	1.14	1.4	V
V <sub>F</sub> **	forward voltage	I <sub>F</sub> = 15 A; T <sub>j</sub> = 25 °C	-	1.4	1.8	V
		I <sub>F</sub> = 15 A; T <sub>j</sub> = 150 °C	-	1	1.4	V
I <sub>R</sub> *	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 25 °C	-	1	10	μA
I <sub>R</sub> **	reverse current	V <sub>R</sub> = 600 V; T <sub>j</sub> = 150 °C	-	-	1	mA
Dynamic	characteristics					
t <sub>rr</sub> **	reverse recovery time	$I_F = 1 \text{ A}; V_R = 30 \text{ V}; dI_F/dt = 100 \text{ A/}\mu\text{s};$ $T_j = 25 ^{\circ}\text{C}$	-	28	60	ns
		$I_F = 15 \text{ A}; V_R = 400 \text{ V}; dI_F/dt = 500 \text{ A/}\mu\text{s};$ $T_j = 25 \text{ °C}$	-	44	-	ns
		$I_F = 15 \text{ A}; V_R = 200 \text{ V}; dI_F/dt = 200 \text{ A}/\mu\text{s};$ $T_j = 25 ^{\circ}\text{C}$	-	50	-	ns

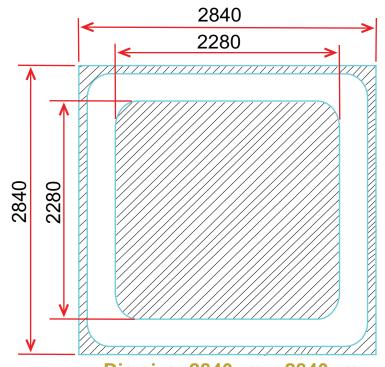
#### Notes:

<sup>(1) \*</sup> mean that parameter are 100% test at  $T_{amb}$  = 25°C

<sup>(2) \*\*</sup> means that the guaranteed ratings and parameter limits will depend on the assembled structure. When correctly assembled with suitable die bonding and wire bonding, the device will have ratings and characteristics guaranteed in this data sheet, similar to the assembled devices in TO-220 package.

MECHANICAL PARAMETER					
Chip size	2.84 x 2.84	mm <sup>2</sup>			
Anode pad size	2.28 x 2.28	mm <sup>2</sup>			
Area total /active	8.07 / 5.20	mm <sup>2</sup>			
Thickness	300	μm			
Wafer size	125	mm			
Max possible chips per wafer	1371	pcs			
Passivation	Glass				
Front metal	Al				
Back metal	Ti Ni Ag				

#### **CHIP LAYOUT**



Die size: 2840μm x 2840μm Bond pad size: 2280μm x 2280μm

## 7. Legal information

#### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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For more information, please visit: http://www.ween-semi.com
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